74LVC257A

Quad 2-input multiplexer with 5 V tolerant inputs/outputs; 3-state

Rev. 6 — 28 November 2011

Product data sheet

1. General description

The 74LVC257A is a quad 2-input multiplexer with 3-state outputs, which select 4 bits of data from two sources and are controlled by a common data select input (pin S). The data inputs from source 0 (pins 1I0 to 4I0) are selected when pin S is LOW and the data inputs from source 1 (pins 1I1 to 4I1) are selected when pin S is HIGH. Data appears at the outputs (pins 1Y to 4Y) in true (non-inverting) form from the selected inputs. The device is the logic implementation of a 4-pole, 2-position switch, where the position of the switch is determined by the logic levels applied to pin S. The outputs are forced to a high-impedance OFF-state when pin $\overline{\text{OE}}$ is HIGH.

Inputs can be driven from either 3.3~V or 5.0~V devices. When disabled, up to 5.5~V can be applied to the outputs. These features allow the use of these devices as translators in mixed 3.3~V and 5~V applications.

2. Features and benefits

- 5 V tolerant inputs/outputs, for interfacing with 5 V logic
- Wide supply voltage range from 1.2 V to 3.6 V
- CMOS low-power consumption
- Direct interface with TTL levels
- Output drive capability 50 Ω transmission lines at 85 °C
- Complies with JEDEC standard:
 - ◆ JESD8-7A (1.65 V to 1.95 V)
 - ◆ JESD8-5A (2.3 V to 2.7 V)
 - ◆ JESD8-C/JESD36 (2.7 V to 3.6 V)
- ESD protection:
 - ◆ HBM JESD22-A114F exceeds 2000 V
 - ♦ MM JESD22-A115B exceeds 200 V
 - ◆ CDM JESD22-C101E exceeds 1000 V
- Specified from -40 °C to +85 °C and -40 °C to +125 °C



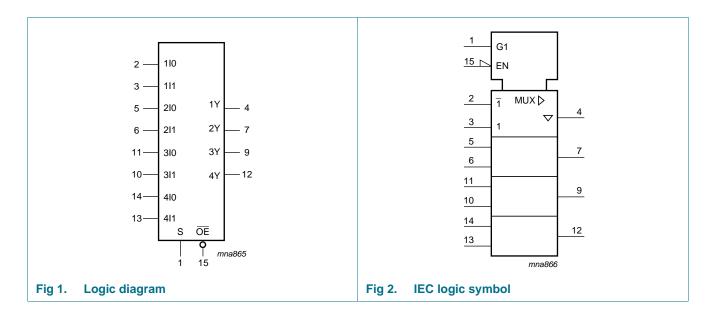
Quad 2-input multiplexer with 5V tolerant; 3-state

3. Ordering information

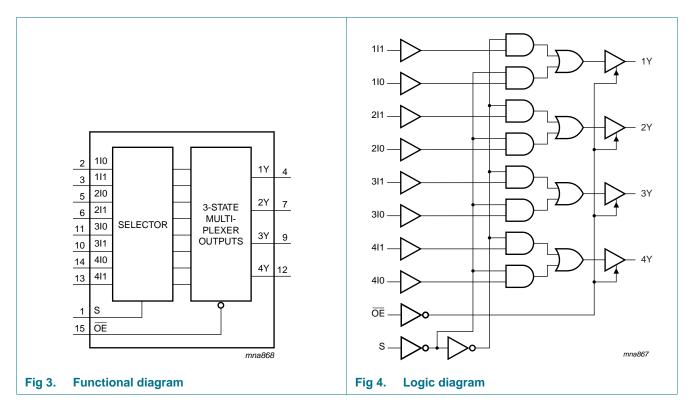
Table 1. Ordering information

Type number	Package	Package Package											
	Temperature range	Name	Description	Version									
74LVC257AD	–40 °C to +125 °C	SO16	plastic small outline package; 16 leads; body width 3.9 mm	SOT109-1									
74LVC257ADB	–40 °C to +125 °C	SSOP16	plastic shrink small outline package; 16 leads; body width 5.3 mm	SOT338-1									
74LVC257APW	–40 °C to +125 °C	TSSOP16	plastic thin shrink small outline package; 16 leads; body width 4.4 mm	SOT403-1									
74LVC257ABQ	–40 °C to +125 °C	DHVQFN16	plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 16 terminals; body 2.5 \times 3.5 \times 0.85 mm	SOT763-1									

4. Functional diagram

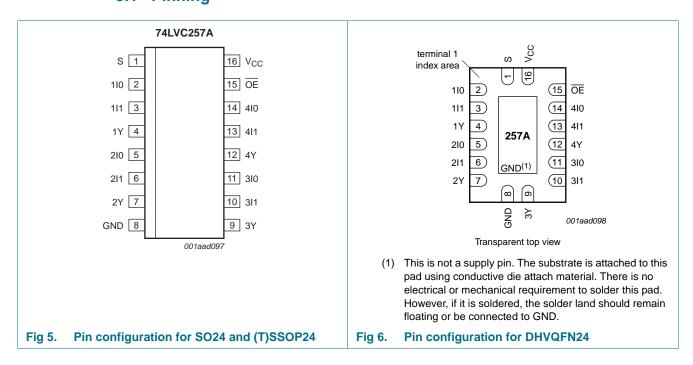


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5. Pinning information

5.1 Pinning



Quad 2-input multiplexer with 5V tolerant; 3-state

5.2 Pin description

Table 2. Pin description

Symbol	Pin	Description
S	1	common data select input
110	2	data input from source 0
111	3	data input from source 1
1Y	4	3-state multiplexer output
210	5	data input from source 0
2l1	6	data input from source 1
2Y	7	3-state multiplexer output
GND	8	ground (0 V)
3Y	9	3-state multiplexer output
3l1	10	data input from source 1
310	11	data input from source 0
4Y	12	3-state multiplexer output
411	13	data input from source 1
410	14	data input from source 0
ŌĒ	15	3-state output enable input (active LOW)
V _{CC}	16	supply voltage

6. Functional description

Table 3. Function table[1]

Input OE		Output		
OE	S	nI0	nl1	nY
Н	X	X	X	Z
L	Н	X	L	L
L	Н	X	Н	Н
L	L	L	X	L
L	L	Н	Χ	Н

^[1] H = HIGH voltage level

L = LOW voltage level

X = don't care

Z = high-impedance OFF-state

Quad 2-input multiplexer with 5V tolerant; 3-state

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{CC}	supply voltage		-0.5	+6.5	V
I _{IK}	input clamping current	V _I < 0	-50	-	mA
V_{I}	input voltage		<u>[1]</u> –0.5	+6.5	V
I _{OK}	output clamping current	$V_O > V_{CC}$ or $V_O < 0$	-	±50	mA
Vo	output voltage	HIGH or LOW state	[2] -0.5	$V_{CC} + 0.5$	V
		output 3-state	[2] -0.5	+6.5	V
Io	output current	$V_O = 0 V \text{ to } V_{CC}$	-	±50	mA
I _{CC}	supply current		-	100	mA
I_{GND}	ground current		-100	-	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	$T_{amb} = -40 ^{\circ}\text{C} \text{ to } +125 ^{\circ}\text{C}$	[3]	500	mW

^[1] The minimum input voltage ratings may be exceeded if the input current ratings are observed.

8. Recommended operating conditions

Table 5. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V_{CC}	supply voltage		1.65	-	3.6	V
		functional	1.2	-	-	V
V_{I}	input voltage		0	-	5.5	V
Vo	output voltage	HIGH or LOW state	0	-	V_{CC}	V
		3-state	0	-	5.5	V
T _{amb}	ambient temperature	in free air	-40	-	+125	°C
$\Delta t/\Delta V$	input transition rise and fall	$V_{CC} = 1.65 \text{ V to } 2.7 \text{ V}$	0	-	20	ns/V
	rate	$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	0	-	10	ns/V

^[2] The output voltage ratings may be exceeded if the output current ratings are observed.

^[3] For SO16 packages: above 70 °C the value of P_{tot} derates linearly with 8 mW/K.
For (T)SSOP16 packages: above 60 °C the value of P_{tot} derates linearly with 5.5 mW/K.
For DHVQFN16 packages: above 60 °C the value of P_{tot} derates linearly with 4.5 mW/K.

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9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40	°C to +8	5 °C	-40 °C to	Unit	
			Min	Typ[1]	Max	Min	Max	
V _{IH}	HIGH-level	V _{CC} = 1.2 V	1.08	-	-	1.08	-	V
	input voltage	V _{CC} = 1.65 V to 1.95 V	$0.65 \times V_{CC}$	-	-	$0.65 \times V_{CC}$	-	V
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	1.7	-	-	1.7	-	V
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	2.0	-	-	2.0	-	V
V _{IL}	LOW-level	V _{CC} = 1.2 V	-	-	0.12	-	0.12	V
	input voltage	V _{CC} = 1.65 V to 1.95 V	-	-	$0.35 \times V_{CC}$	-	$0.35 \times V_{CC}$	V
		V _{CC} = 2.3 V to 2.7 V	-	-	0.7	-	0.7	V
		V _{CC} = 2.7 V to 3.6 V	-	-	0.8	-	0.8	V
V_{OH}	HIGH-level	$V_I = V_{IH}$ or V_{IL}						
	output voltage	$I_O = -100 \mu A;$ $V_{CC} = 1.65 \text{ V to } 3.6 \text{ V}$	V _{CC} - 0.2	-	-	V _{CC} – 0.3	-	V
		$I_{O} = -4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	1.2	-	-	1.05	-	V
		$I_{O} = -8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.8	-	-	1.65	-	V
		$I_{O} = -12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	2.2	-	-	2.05	-	V
		$I_{O} = -18 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.4	-	-	2.25	-	V
		$I_{O} = -24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.2	-	-	2.0	-	V
~-	LOW-level	$V_I = V_{IH}$ or V_{IL}						
	output voltage	$I_O = 100 \mu A;$ $V_{CC} = 1.65 \text{ V to } 3.6 \text{ V}$	-	-	0.2	-	0.3	V
		$I_O = 4 \text{ mA}$; $V_{CC} = 1.65 \text{ V}$	-	-	0.45	-	0.65	V
		$I_O = 8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.6	-	0.8	V
		$I_{O} = 12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	-	-	0.4	-	0.6	V
		$I_O = 24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.55	-	0.8	V
II	input leakage current	$V_{CC} = 3.6 \text{ V}; V_{I} = 5.5 \text{ V or GND}$	-	±0.1	±5	-	±20	μΑ
l _{OZ}	OFF-state output current	$V_I = V_{IH}$ or V_{IL} ; $V_{CC} = 3.6$ V; $V_O = 5.5$ V or GND;	-	±0.1	±5	-	±20	μΑ
I _{OFF}	power-off leakage current	$V_{CC} = 0 \text{ V}; V_{I} \text{ or } V_{O} = 5.5 \text{ V}$	-	±0.1	±10	-	±20	μΑ
I _{CC}	supply current	V_{CC} = 3.6 V; V_I = V_{CC} or GND; I_O = 0 A	-	0.1	10	-	40	μΑ
ΔI_{CC}	additional supply current	per input pin; $V_{CC} = 2.7 \text{ V to } 3.6 \text{ V};$ $V_I = V_{CC} - 0.6 \text{ V}; I_O = 0 \text{ A}$	-	5	500	-	5000	μΑ
Cı	input capacitance	$V_{CC} = 0 \text{ V to } 3.6 \text{ V};$ $V_{I} = \text{GND to } V_{CC}$	-	5.0	-	-	-	pF

^[1] All typical values are measured at V_{CC} = 3.3 V (unless stated otherwise) and T_{amb} = 25 °C.

Quad 2-input multiplexer with 5V tolerant; 3-state

10. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 9.

Symbol	Parameter	Conditions		-40	°C to +8	5 °C	-40 °C to	+125 °C	Unit
				Min	Typ[1]	Max	Min	Max	
t _{pd}	propagation delay	nl0, nl1 to nY; see Figure 7	[2]		'				
		V _{CC} = 1.2 V		-	16	-	-	-	ns
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		1.5	5.2	10.6	1.5	12.3	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		1.0	2.8	5.5	1.0	6.4	ns
		$V_{CC} = 2.7 \text{ V}$		1.0	2.8	5.4	1.0	7.0	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		1.0	2.4	4.6	1.0	6.0	ns
		S to nY; see Figure 7	[2]						
		V _{CC} = 1.2 V		-	18	-	-	-	ns
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		1.0	6.0	14.8	1.0	17.1	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		1.0	3.2	7.7	1.0	8.9	ns
		$V_{CC} = 2.7 \text{ V}$		1.0	3.2	7.5	1.0	9.5	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		1.0	2.7	6.4	1.0	8.0	ns
t _{en}	enable time	OE to nY; see Figure 8	[2]						
		V _{CC} = 1.2 V		-	15	-	-	-	ns
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		1.5	5.8	12.7	1.5	14.7	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		1.5	3.3	7.0	1.5	8.1	ns
		$V_{CC} = 2.7 \text{ V}$		1.5	3.4	6.7	1.5	8.5	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		1.0	2.7	5.6	1.0	7.0	ns
t _{dis}	disable time	OE to nY; see Figure 8	[2]						
		V _{CC} = 1.2 V		-	8	-	-	-	ns
		V_{CC} = 1.65 V to 1.95 V		2.2	4.0	8.2	2.2	9.4	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		0.5	2.2	4.4	0.5	5.1	ns
		$V_{CC} = 2.7 \text{ V}$		1.5	3.0	4.7	1.5	6.0	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		1.0	2.8	4.3	1.0	5.5	ns
t _{sk(o)}	output skew time	$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	[3]	-	-	1.0	-	1.5	ns

Quad 2-input multiplexer with 5V tolerant; 3-state

 Table 7.
 Dynamic characteristics ...continued

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 9.

Symbol	Parameter	Conditions	-40	°C to +8	5 °C	–40 °C to	+125 °C	Unit	
				Min	Typ[1]	Max	Min	Max	
C _{PD} power dissipation capacitance	per input; $V_I = GND$ to V_{CC}	<u>[4]</u>						'	
	$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		-	8.0	-	-	-	pF	
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		-	11.4	-	-	-	pF
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		-	14.4	-	-	-	pF

- [1] Typical values are measured at $T_{amb} = 25$ °C and $V_{CC} = 1.2$ V, 1.8 V, 2.5 V, 2.7 V, and 3.3 V respectively.
- $\begin{array}{ll} \text{[2]} & t_{\text{pd}} \text{ is the same as } t_{\text{PLH}} \text{ and } t_{\text{PHL}}. \\ & t_{\text{en}} \text{ is the same as } t_{\text{PZL}} \text{ and } t_{\text{PZH}}. \end{array}$
 - t_{dis} is the same as t_{PLZ} and t_{PHZ} .
- [3] Skew between any two outputs of the same package switching in the same direction. This parameter is guaranteed by design.
- [4] C_{PD} is used to determine the dynamic power dissipation (P_D in μW).

 $P_D = C_{PD} \times V_{CC}{}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}{}^2 \times f_o)$ where:

f_i = input frequency in MHz; f_o = output frequency in MHz

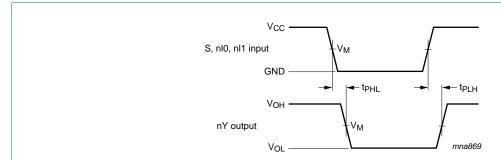
C_L = output load capacitance in pF

V_{CC} = supply voltage in Volts

N = number of inputs switching

 $\Sigma(C_L \times V_{CC}^2 \times f_0)$ = sum of the outputs

11. Waveforms



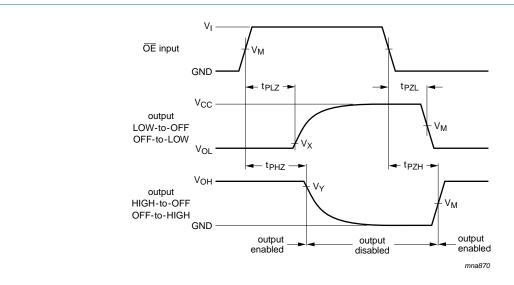
 V_{M} = 1.5 V at $V_{CC} \geq$ 2.7 V;

 V_{M} = 0.5 $\,\times\,V_{CC}$ at V_{CC} < 2.7 V;

 V_{OL} and V_{OH} are typical output voltage levels that occur with the output load.

Fig 7. Input (S, nI0 and nI1) to output (nY) propagation delays

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 V_M = 1.5 V at $V_{CC} \ge 2.7$ V.

 V_{M} = 0.5 \times V_{CC} at V_{CC} < 2.7 V.

 $V_{\mbox{\scriptsize OL}}$ and $V_{\mbox{\scriptsize OH}}$ are typical output voltage levels that occur with the output load.

 $V_X = V_{OL} + 0.3 \text{ V at } V_{CC} \ge 2.7 \text{ V};$

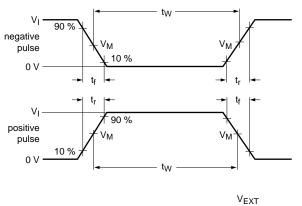
 $V_X = V_{OL} + 0.15 \text{ V at } V_{CC} < 2.7 \text{ V};$

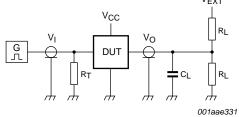
 V_{Y} = $V_{OH} - 0.3 \ V$ at $V_{CC} \geq 2.7 \ V;$

 V_{Y} = $V_{OH} - 0.15 \ V$ at $V_{CC} < 2.7 \ V.$

Fig 8. 3-state enable and disable times

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Test data is given in Table 8.

Definitions for test circuit:

 R_L = Load resistance.

 C_L = Load capacitance including jig and probe capacitance.

 R_T = Termination resistance should be equal to output impedance Z_0 of the pulse generator.

V_{EXT} = External voltage for measuring switching times.

Fig 9. Test circuit for measuring switching times

Table 8. Test data

Supply voltage	Input		Load		V _{EXT}	V _{EXT}			
	VI			t _{PLH} , t _{PHL}	t_{PLZ}, t_{PZL}	t _{PHZ} , t _{PZH}			
1.2 V	V_{CC}	≤ 2 ns	30 pF	1 k Ω	open	$2\times V_{CC}$	GND		
1.65 V to 1.95 V	V_{CC}	≤ 2 ns	30 pF	1 kΩ	open	$2\times V_{CC}$	GND		
2.3 V to 2.7 V	V_{CC}	≤ 2 ns	30 pF	500Ω	open	$2\times V_{CC}$	GND		
2.7 V	2.7 V	≤ 2.5 ns	50 pF	500Ω	open	$2\times V_{CC}$	GND		
3.0 V to 3.6 V	2.7 V	≤ 2.5 ns	50 pF	500Ω	open	$2\times V_{CC}$	GND		

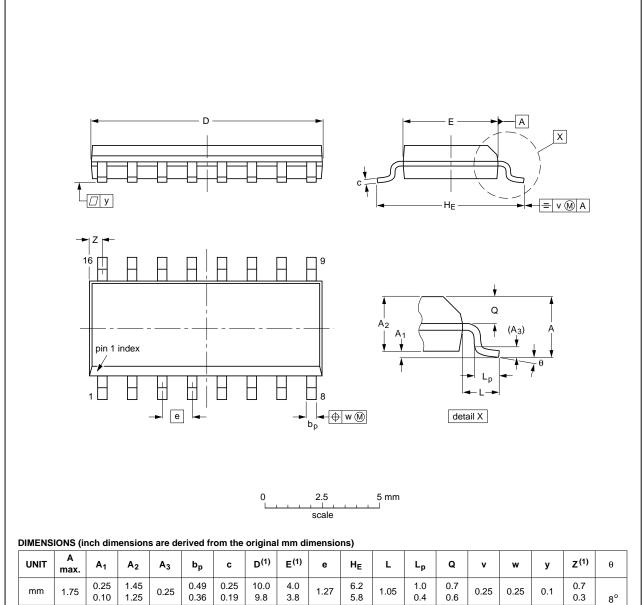
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12. Package outline

SO16: plastic small outline package; 16 leads; body width 3.9 mm

SOT109-1



UNIT	A max.	A ₁	A ₂	A ₃	bp	С	D ⁽¹⁾	E ⁽¹⁾	е	HE	L	Lp	ø	v	w	у	Z ⁽¹⁾	θ
mm	1.75	0.25 0.10	1.45 1.25	0.25	0.49 0.36	0.25 0.19	10.0 9.8	4.0 3.8	1.27	6.2 5.8	1.05	1.0 0.4	0.7 0.6	0.25	0.25	0.1	0.7 0.3	8°
inches	0.069	0.010 0.004	0.057 0.049	0.01		0.0100 0.0075		0.16 0.15	0.05	0.244 0.228	0.041	0.039 0.016	0.028 0.020	0.01	0.01	0.004	0.028 0.012	0°

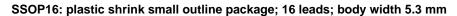
Note

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

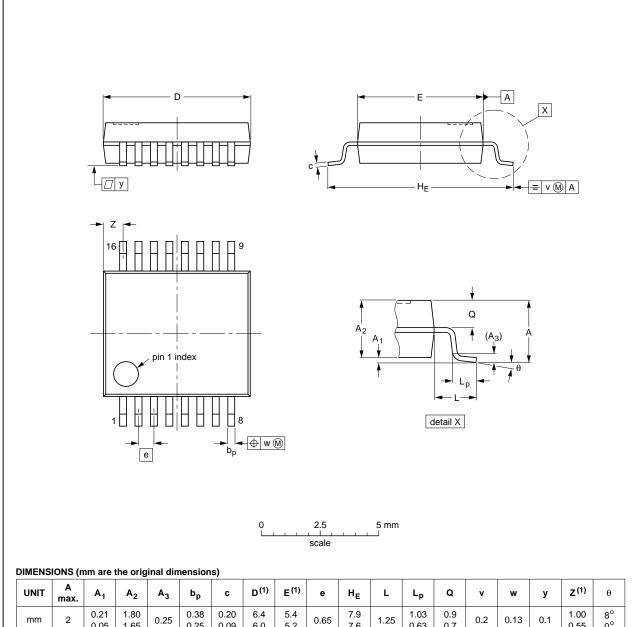
OUTLINE		REFER	EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT109-1	076E07	MS-012				99-12-27 03-02-19

Fig 10. Package outline SOT109-1 (SO16)

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SOT338-1



UNIT	A max.	A ₁	A ₂	A ₃	b _p	С	D ⁽¹⁾	E ⁽¹⁾	е	HE	L	Lp	Q	v	w	у	Z ⁽¹⁾	θ	
mm	2	0.21 0.05	1.80 1.65	0.25	0.38 0.25	0.20 0.09	6.4 6.0	5.4 5.2	0.65	7.9 7.6	1.25	1.03 0.63	0.9 0.7	0.2	0.13	0.1	1.00 0.55	8° 0°	

Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

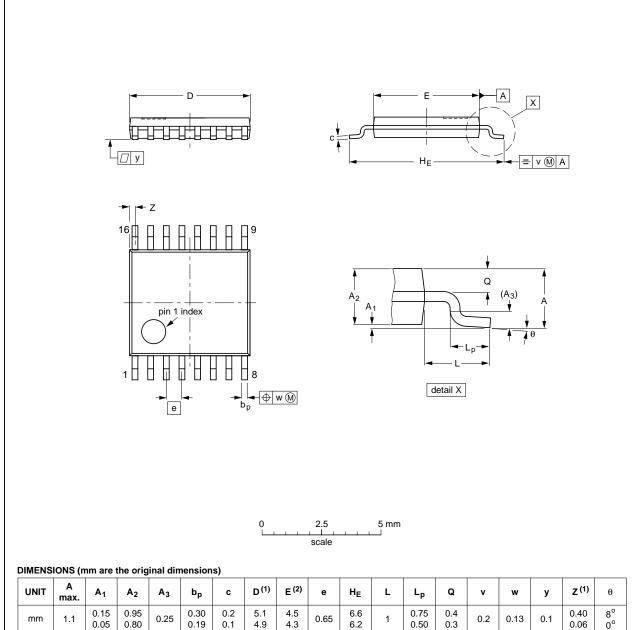
OUTLINE	REFERENCES			EUROPEAN	ICCUE DATE	
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT338-1		MO-150				99-12-27 03-02-19

Fig 11. Package outline SOT338-1 (SSOP16)

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TSSOP16: plastic thin shrink small outline package; 16 leads; body width 4.4 mm

SOT403-1



- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE	REFERENCES				EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT403-1		MO-153				99-12-27 03-02-18

Fig 12. Package outline SOT403-1 (TSSOP16)

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DHVQFN16: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 16 terminals; body 2.5 x 3.5 x 0.85 mm SOT763-1

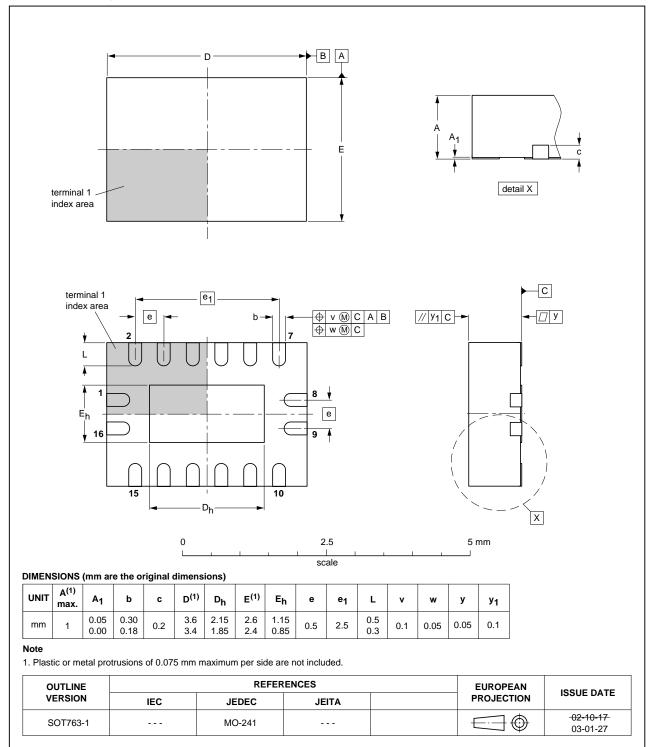


Fig 13. Package outline SOT763-1 (DHVQFN16)

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Quad 2-input multiplexer with 5V tolerant; 3-state

13. Abbreviations

Table 9. Abbreviations

Acronym	Description
CDM	Charged Device Model
DUT	Device Under Test
ESD	ElectroStatic Discharge
НВМ	Human Body Model
MM	Machine Model
TTL	Transistor-Transistor Logic

14. Revision history

Table 10. Revision history

	•					
Document ID	Release date	Data sheet status	Change notice	Supersedes		
74LVC257A v.6	20111128	Product data sheet	-	74LVC257A v.5		
Modifications:	 Value changes 	s for t _{pd} , t _{en} and t _{dis} in <u>Table</u>	7 "Dynamic characteris	etics"		
	 Typographical 	errors corrected				
74LVC257A v.5	20111108	Product data sheet	-	74LVC257A v.4		
Modifications:	 The format of this document has been redesigned to comply with the new identity guidelines of NXP Semiconductors. 					
	 Legal texts have been adapted to the new company name where appropriate. 					
	• <u>Table 4</u> , <u>Table 5</u> , <u>Table 6</u> , <u>Table 7</u> and <u>Table 8</u> : values added for lower voltage ranges.					
74LVC257A v.4	040123	Product specification	-	74LVC257A v.3		
74LVC257A v.3	031117	Product specification	-	74LVC257A v.2		
74LVC257A v.2	980729	Product specification	-	74LVC257A v.1		
74LVC257A v.1	-	-	-	-		

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15. Legal information

15.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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